

HAT2172H

Silicon N Channel Power MOS FET Power Switching

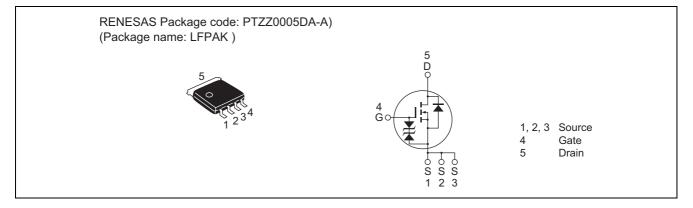
REJ03G0132-0500 Rev.5.00 Sep 20, 2005

Features

- High speed switching
- Capable of 7 V gate drive
- Low drive current
- High density mounting
- Low on-resistance

 $R_{DS(on)} = 5.8 \text{ m}\Omega \text{ typ.}$ (at $V_{GS} = 10 \text{ V}$)

Outline



Absolute Maximum Ratings

			$(Ta = 25^{\circ}C)$
Item	Symbol	Ratings	Unit
Drain to source voltage	V _{DSS}	40	V
Gate to source voltage	V _{GSS}	±20	V
Drain current	I _D	30	A
Drain peak current	Note1 I _{D(pulse)}	120	A
Body-drain diode reverse drain current	I _{DR}	30	A
Avalanche current	I _{AP} Note 2	20	A
Avalanche energy	E _{AR} Note 2	32	mJ
Channel dissipation	Pch Note3	20	W
Channel to Case Thermal Resistance	θch-C	6.25	°C/W
Channel temperature	Tch	150	٥°C
Storage temperature	Tstg	-55 to +150	°C

Notes: 1. PW \leq 10 µs, duty cycle \leq 1%

2. Value at Tch = 25° C, Rg $\geq 50 \Omega$

3. Tc = 25°C



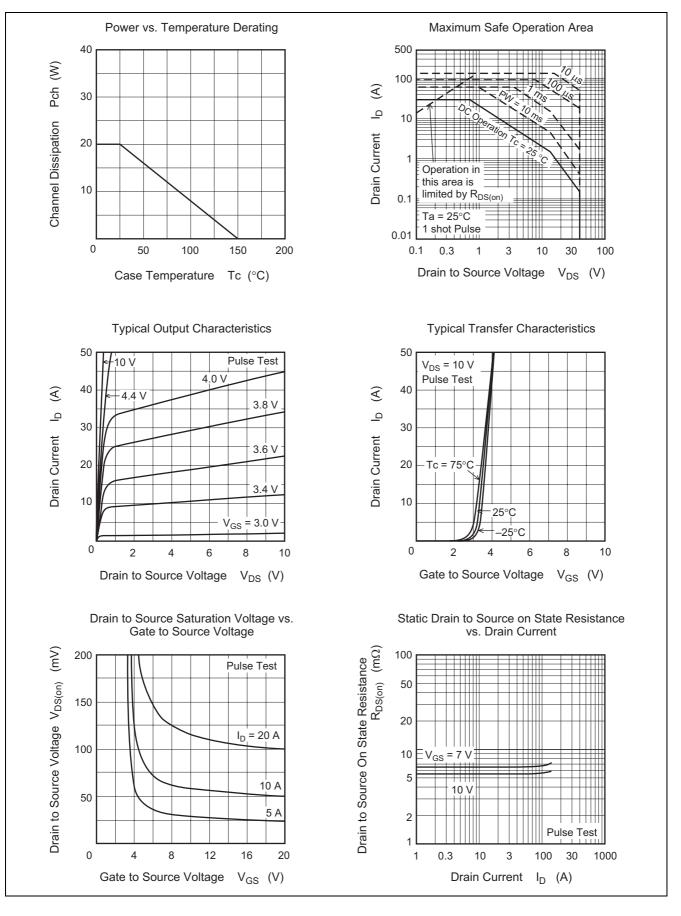
Electrical Characteristics

					$(Ta = 25^{\circ}C)$
Symbol	Min	Тур	Max	Unit	Test Conditions
V _{(BR)DSS}	40	—	_	V	$I_D = 10 \text{ mA}, V_{GS} = 0$
V _{(BR)GSS}	±20	—	_	V	$I_G = \pm 100 \ \mu A, \ V_{DS} = 0$
I _{GSS}	_	_	±10	μΑ	$V_{GS} = \pm 16 \text{ V}, V_{DS} = 0$
I _{DSS}	_	_	1	μΑ	$V_{DS} = 40 V, V_{GS} = 0$
V _{GS(off)}	1.5	_	3.0	V	$V_{DS} = 10 \text{ V}, \text{ I}_{D} = 1 \text{ mA}$
R _{DS(on)}	_	5.8	7.5	mΩ	$I_D = 15 \text{ A}, V_{GS} = 10 \text{ V}^{Note4}$
R _{DS(on)}		6.6	9.2	mΩ	$I_D = 15 \text{ A}, V_{GS} = 7 \text{ V}^{Note4}$
y _{fs}	27	45	_	S	$I_D = 15 \text{ A}, V_{DS} = 10 \text{ V}^{Note4}$
Ciss		2420	_	pF	$V_{DS} = 10 V, V_{GS} = 0,$
Coss		480	_	pF	f = 1 MHz
Crss	_	150		pF	
Rg		0.5	_	Ω	
Qg		32	_	nC	$V_{DD} = 10 \text{ V}, \text{ V}_{GS} = 10 \text{ V},$ $I_D = 30 \text{ A}$
Qgs		9	_	nC	
Qgd		4.0	_	nC	
t _{d(on)}	_	12		ns	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 15 \text{ A},$
tr		20	_	ns	
t _{d(off)}	_	38		ns	
t _f	_	4.5	_	ns	
V _{DF}	_	0.84	1.10	V	$IF = 30 A, V_{GS} = 0^{Note4}$
t _{rr}	_	32	_	ns	IF = 30 A, V _{GS} = 0
					di _F / dt = 100 A/ μs
	V(BR)DSS V(BR)GSS IGSS IDSS VGS(off) RDS(on) RDS(on) IVfs Ciss Coss Crss Rg Qg Qgd td(on) tr td(off) tf VDF	V(BR)DSS 40 V(BR)GSS ±20 IGSS IDSS VGS(off) 1.5 RDS(on) RDS(on) Iyfs 27 Ciss COSS Rg Qg Qgd td(on) tr tf VDF	$\begin{array}{c c c c c c c c c c c c c c c c c c c $	$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	$\begin{array}{c ccccccccccccccccccccccccccccccccccc$

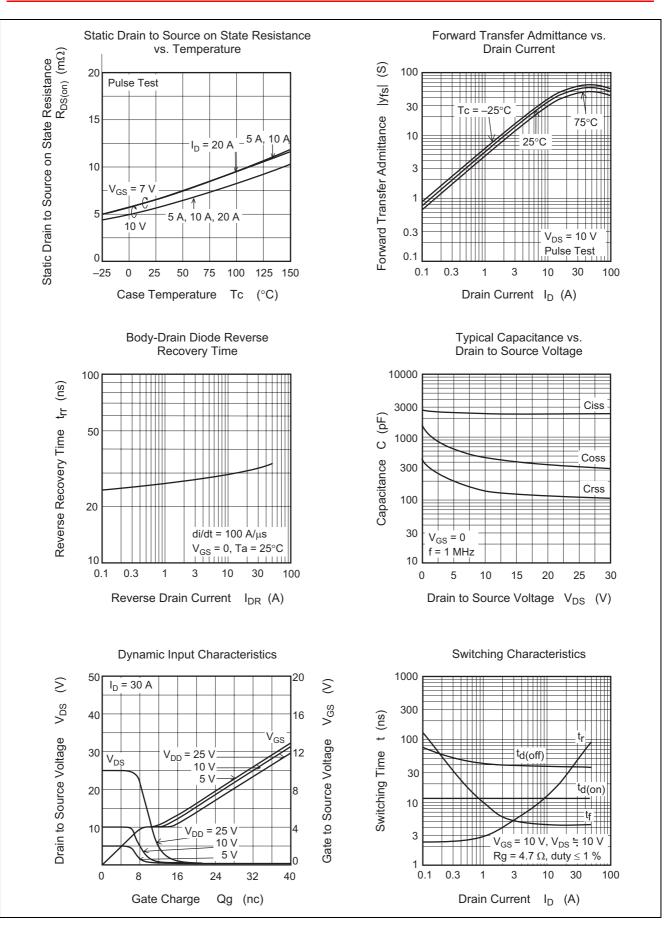
Notes: 4. Pulse test



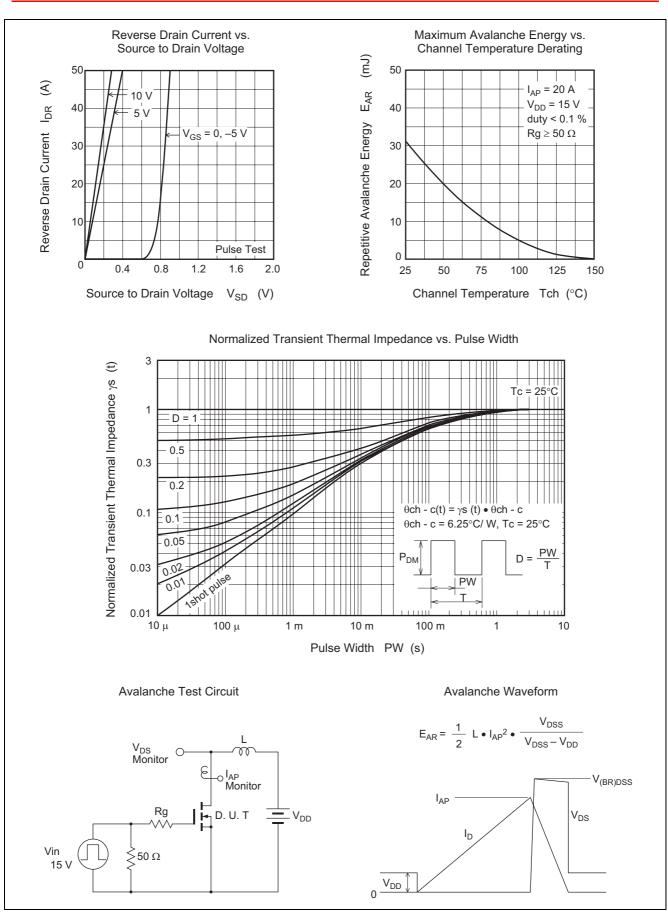
Main Characteristics



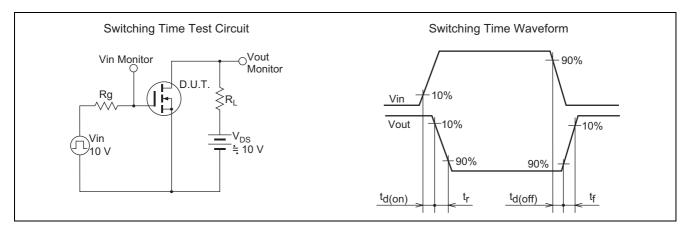






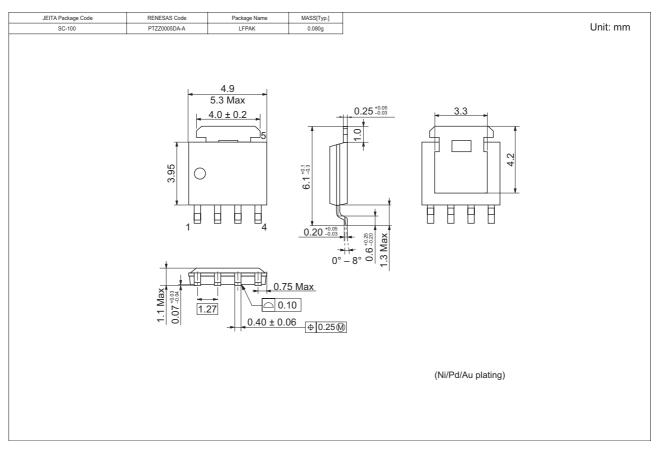








Package Dimensions



Ordering Information

Part Name	Quantity	Shipping Container
HAT2172H-EL-E	2500 pcs	Taping

Note: For some grades, production may be terminated. Please contact the Renesas sales office to check the state of production before ordering the product.



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